Wire Wound Chip Ferrite Bead -SPH-Z Series

Operating Temp. : -40℃~+125℃



FEATURES

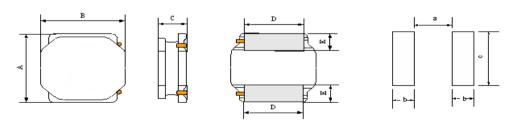
- Magnetic-resin shielded construction reduces buzz noise to ultra-low levels
- Metallization on ferrite core results in excellent shock resistance and damage-free durability
- Closed magnetic circuit design reduces leakage flux and Electro Magnetic Interference (EMI)
- Subface electrodes, appropriate for SMT

APPLICATIONS

- Patch Filter
- Noise suppression for power line or large current signal of electric equipments such as computers and peripheral devices, DVD cameras, LCD TVs, communication equipments, OA equipments, etc.

PRODUCT IDENTIFICATION <u>H</u> SPH 3015 Z151 <u>T</u> (1) (2)(3) (1) External Dimensions (LxW) (mm) Feature type Type 3015 3.0 X 3.0 X 1.5 Wire Wound Chip Н H Type Material SPH Ferrite Bead For Large (5)Current Impedance Tolerance ±30% Μ ±20% $\overline{7}$ (4) Special Process Code Nominal Impedance (6) Special Process XXX Nominal Value Example Code Packing Z3R3 3.3Ω * Standard product is blank Т Z151 150Ω Tape & Reel

SHAPE AND DIMENSIONS



Series	Α	В	С	D	Е	а	b	С
SPH3015HZ	3.0±0.2	3.0±0.2	1.5Max.	2.5±0.2	0.75±0.2	1.5Typ.	0.8Typ.	2.7Typ.

SPECIFICATIONS

SPH3015HZ TYPE

	Impedance	DC Resistance		Heat Rat		
Part Number	1MHz,1V	Max.	Тур.		※2 Ambient temperature 105°C	Marking
Units	Ω	Ω	Ω	mA	mA	
Symbol	Z	DCR		lı	-	
SPH3015HZ3R3NT	3.3±30%	0.019	0.016	2900	1500	N/A
SPH3015HZ6R8NT	6.8±30%	0.040	0.033	2500	1380	N/A
SPH3015HZ8R4NT	8.4±30%	0.048	0040	2400	1360	N/A
SPH3015HZ9R8NT	9.8±30%	0.048	0.040	2100	1110	N/A
SPH3015HZ120NT	12±30%	0.060	0.050	1850	910	N/A
SPH3015HZ190NT	19±30%	0.084	0.070	1800	900	N/A
SPH3015HZ210NT	21±30%	0.115	0.096	1550	800	N/A
SPH3015HZ310NT	31±30%	0.115	0.096	1200	610	N/A
SPH3015HZ520NT	52±30%	0.276	0.230	1100	550	N/A
SPH3015HZ650NT	65±30%	0.276	0.230	900	450	N/A
SPH3015HZ101NT	100±30%	0.468	0.390	900	330	N/A
SPH3015HZ151NT	150±30%	0.768	0.640	490	300	N/A

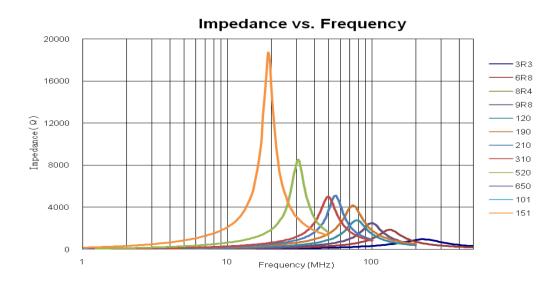
Note: 1: When applied rated current to the Products, temperature rise caused by self heating will be 40°C or less.

*2: When applied rated current to the Products, temperature rise caused by self heating will be 20°C or less.

The part temperature (ambient + temp. rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

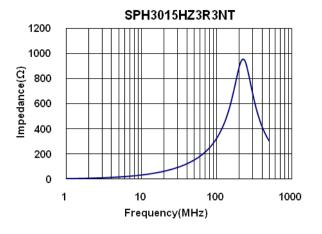
TYPICAL ELECTRICAL CHARACTERISTICS

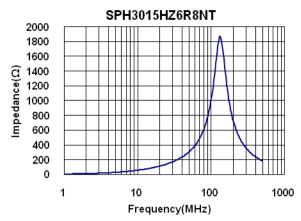
SPH3015HZ Series

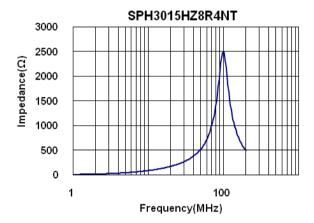


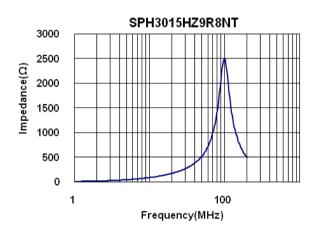
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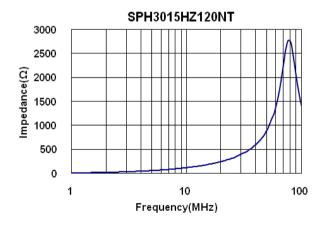
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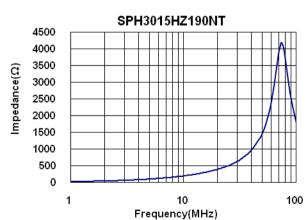












TYPICAL ELECTRICAL CHARACTERISTICS

SPH3015HZ Series

